

LT1189

Low Power Video Difference Amplifier

FEATURES

- Differential or Single-Ended Gain Block (Adjustable)
- -3dB Bandwidth, A_V = ± 10
- Slew Rate
- Low Supply Current
- Output Current
- CMRR at 10MHz
- LT1193 Pin Out
- Low Cost
- Single 5V Operation
- Drives Cables Directly
- Output Shutdown

APPLICATIONS

- Line Receivers
- Video Signal Processing
- Cable Drivers
- Tape and Disc Drive Systems

DESCRIPTION

35MHz

13mA

48dB

±20mA

220V/µs

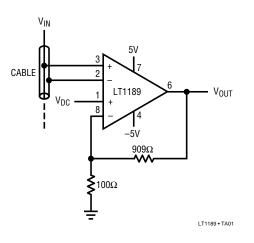
The LT1189 is a difference amplifier optimized for operation on \pm 5V, or a single 5V supply, and gain \geq 10. This versatile amplifier features uncommitted high input impedance (+) and (–) inputs, and can be used in differential or single-ended configurations. Additionally, a second set of inputs give gain adjustment and DC control to the difference amplifier.

The LT1189's high slew rate, $220V/\mu s$, wide bandwidth, 35MHz, and $\pm 20mA$ output current require only 13mA of supply current. The shutdown feature reduces the power dissipation to a mere 15mW, and allows multiple amplifiers to drive the same cable.

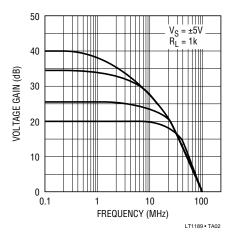
The LT1189 is a low power, gain of 10 stable version of the popular LT1193, and is available in 8-pin miniDIPs and SO packages. For lower gain applications see the LT1187 data sheet.

TYPICAL APPLICATION

Cable Sense Amplifier for Loop Through Connections with DC Adjust



Closed-Loop Gain vs Frequency



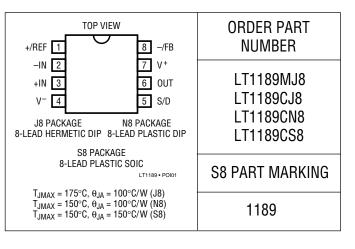


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ABSOLUTE MAXIMUM RATINGS

Total Supply Voltage (V ⁺ to V ⁻) 18V Differential Input Voltage ±6V
Input Voltage ±V _S
Output Short Circuit Duration (Note 1) Continuous
Operating Temperature Range
LT1189M55°C to 150°C
LT1189C 0°C to 70°C
Junction Temperature (Note 2)
Plastic Package (CN8,CS8) 150°C
Ceramic Package (CJ8,MJ8) 175°C
Storage Temperature Range –65°C to 150°C
Lead Temperature (Soldering, 10 sec.) 300°C

PACKAGE/ORDER INFORMATION



$\pm 5V \ \ \textbf{ELECTRICAL CHARACTERISTICS} \quad \textbf{T}_{A} = 25^{\circ}\text{C}, \ (\text{Note 3}) \\ \textbf{V}_{S} = \pm 5\text{V}, \ \textbf{V}_{REF} = 0\text{V}, \ \textbf{R}_{FB1} = 900\Omega \ \text{from pins 6 to 8}, \ \textbf{R}_{FB2} = 100\Omega \ \text{from pin 8 to ground}, \ \textbf{R}_{L} = \textbf{R}_{FB1} + \textbf{R}_{FB2} = 1\text{k}, \ \textbf{C}_{L} \leq 10\text{pF}, \ \text{pin 5 open}.$

SYMBOL	DADAMETED	CONDITIONS		LT1189M		LINUTO
	PARAMETER		MIN	TYP	MAX	UNITS
V _{OS}	Input Offset Voltage	Either Input, (Note 4) SOIC Package		1.0 1.0	3.0 4.0	mV mV
I _{OS}	Input Offset Current	Either Input		0.2	1.0	μΑ
I _B	Input Bias Current	Either Input		±0.5	±2.0	μA μA
e _n	Input Noise Voltage	$f_0 = 10$ kHz		30	12.0	nV/√Hz
	Input Noise Current	$f_0 = 10 \text{ Hz}$		1.25		pA/√Hz
R _{IN}	Input Resistance	Differential		30		μΑν (112 kΩ
	1					
CIN	Input Capacitance	Either Input		2.0		pF
V _{IN LIM}	Input Voltage Limit	(Note 5)		±170		mV
	Input Voltage Range		-2.5		3.5	V
CMRR	Common-Mode Rejection Ratio	$V_{CM} = -2.5V \text{ to } 3.5V$	80	105		dB
PSRR	Power Supply Rejection Ratio	$V_{\rm S} = \pm 2.375 V \text{ to } \pm 8 V$	75	90		dB
V _{OUT}	Output Voltage Swing	$V_{S} = \pm 5V, R_{L} = 1k, A_{V} = 50$	±3.8	±4.0		V
		$V_{S} = \pm 8V, R_{L} = 1k, A_{V} = 50$	±6.7	±7.0]
		$V_{S} = \pm 8V, R_{L} = 300\Omega, A_{V} = 50, (Note 3)$	±6.4	±6.8		
G _E	Gain Error	$V_0 = \pm 1.0 V, A_V = 10$		1.0	3.5	%
SR	Slew Rate	(Note 6, 10)	150	220		V/µs
FPBW	Full Power Bandwidth	$V_0 = 2V_{P-P}$, (Note 7)		35		MHz
BW	Small Signal Bandwidth	A _V = 10		35		MHz
t _r , t _f	Rise Time, Fall Time	$A_V = 50, V_0 = \pm 1.5V, 20\%$ to 80% (Note 10)	35	50	75	ns
t _{PD}	Propagation Delay	R_L = 1k, V_0 = ±125mV, 50% to 50%		12		ns
	Overshoot	$V_0 = \pm 50 mV$		10		%
ts	Settling Time	3V Step, 0.1%, (Note 8)		1		μs
Diff A _V	Differential Gain	R _L = 1k, A _V = 10, (Note 9)		0.6		%
Diff Ph	Differential Phase	R _L = 1k, A _V = 10, (Note 9)		0.75		DEG _{P-P}
I _S	Supply Current			13	16	mA
	Shutdown Supply Current	Pin 5 at V ⁻		0.8	1.5	mA



±5V ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$, (Note 3) $V_S = \pm 5V$, $V_{REF} = 0V$, $R_{FB1} = 900\Omega$ from pins 6 to 8, $R_{FB2} = 100\Omega$ from pin 8 to ground, $R_L = R_{FB1} + R_{FB2} = 1k$, $C_L \le 10pF$, pin 5 open.

			LT1189M/C		
SYMBOL	PARAMETER	CONDITIONS	MIN TYP MAX	UNITS	
I _{S/D}	Shutdown Pin Current	Pin 5 at V ⁻	5 25	μA	
t _{on}	Turn On Time	Pin 5 from V ⁻ to Ground, $R_L = 1k$	500	ns	
t _{off}	Turn Off Time	Pin 5 from Ground to V ⁻ , $R_L = 1k$	600	ns	

5V ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$, (Note 3)

 $V_{S}^{+} = 5V$, $V_{S}^{-} = 0V$, $V_{REF} = 2.5V$, $R_{FB1} = 900\Omega$ from pins 6 to 8, $R_{FB2} = 100\Omega$ from pin 8 to V_{REF} , $R_{L} = R_{FB1} + R_{FB2} = 1k$, $C_{L} \le 10$ pF, pin 5

open.					LT1189M	/C	
SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V _{OS}	Input Offset Voltage	Either Input, (Note 4) SOIC Package			1.0 1.0	3.0 5.0	mV mV
I _{OS}	Input Offset Current	Either Input			0.2	1.0	μA
I _B	Input Bias Current	Either Input			±0.5	±2.0	μA
	Input Voltage Range			2.0		3.5	V
CMRR	Common-Mode Rejection Ratio	V _{CM} = 2.0V to 3.5V		80	100		dB
V _{OUT}	Output Voltage Swing	Dutput Voltage Swing $R_L = 300\Omega$ to Ground	V _{OUT} High	3.6	4.0		V
		(Note 3)	V _{OUT} Low		0.15	0.4	
SR	Slew Rate	V ₀ = 1.5V to 3.5V	·		175		V/µs
BW	Small-Signal Bandwidth	A _V = 10			30		MHz
Is	Supply Current				12	15	mA
	Shutdown Supply Current	Pin 5 at V ⁻			0.8	1.5	mA
I _{S/D}	Shutdown Pin Current	Pin 5 at V [−]			5	25	μA

$\pm 5V$ ELECTRICAL CHARACTERISTICS $-55^{\circ}C \le T_A \le 125^{\circ}C$, (Note 3)

 $V_{S} = \pm 5V$, $V_{REF} = 0V$, $R_{FB1} = 900\Omega$ from pins 6 to 8, $R_{FB2} = 100\Omega$ from pin 8 to ground, $R_{L} = R_{FB1} + R_{FB2} = 1k$, $C_{L} \le 10$ pF, pin 5 open.

SYMBOL	PARAMETER	CONDITIONS	MIN	LT1189N Typ	1 MAX	UNITS
V _{OS}	Input Offset Voltage	Either Input, (Note 4)		1.0	7.5	mV
$\Delta V_{0S} / \Delta T$	Input V _{OS} Drift			10		μV/°C
I _{OS}	Input Offset Current	Either Input		0.2	1.5	μA
I _B	Input Bias Current	Either Input		±0.5	±3.5	μA
	Input Voltage Range		-2.5		3.5	V
CMRR	Common-Mode Rejection Ratio	V _{CM} = -2.5V to 3.5V	80	105		dB
PSRR	Power Supply Rejection Ratio	$V_{\rm S} = \pm 2.375 V \text{ to } \pm 8 V$	65	90		dB
V _{OUT}	Output Voltage Swing	$V_{S} = \pm 5V, R_{L} = 1k, A_{V} = 50$	±3.7	±4.0		V
		$V_{S} = \pm 8V, R_{L} = 1k, A_{V} = 50$	±6.6	±7.0		
		$V_{S} = \pm 8V, R_{L} = 300\Omega, A_{V} = 50, (Note 3)$	±6.4	±6.6		
G _E	Gain Error	$V_0 = \pm 1V, A_V = 10, R_L = 1k$		1.0	6.0	%
ls	Supply Current			13	17	mA
	Shutdown Supply Current	Pin 5 at V ⁻ , (Note 11)		0.8	1.5	mA
I _{S/D}	Shutdown Pin Current	Pin 5 at V ⁻		5	25	μA



±5V ELECTRICAL CHARACTERISTICS $0^{\circ}C \le T_A \le 70^{\circ}C$, (Note 3) V_S = ±5V, V_{REF} = 0V, R_{FB1} = 900Ω from pins 6 to 8, R_{FB2} = 100Ω from pin 8 to ground, R_L = R_{FB1} + R_{FB2} = 1k, C_L ≤ 10pF, pin 5 open.

SYMBOL	PARAMETER	CONDITIONS	MIN	LT11890 TYP	; MAX	UNITS
V _{OS}	Input Offset Voltage (Note 4)	Either Input SOIC Package		1.0 1.0	3.0 6.0	mV mV
$\Delta V_{0S} / \Delta T$	Input V _{OS} Drift			5.0		μV/°C
l _{os}	Input Offset Current	Either Input		0.2	1.5	μA
IB	Input Bias Current	Either Input		±0.5	±3.5	μA
	Input Voltage Range		-2.5		3.5	V
CMRR	Common-Mode Rejection Ratio	V _{CM} = -2.5V to 3.5V	80	105		dB
PSRR	Power Supply Rejection Ratio	V _S = ±2.375V to ±8V	70	90		dB
V _{OUT}	Output Voltage Swing	$V_{\rm S} = \pm 5 V, R_{\rm L} = 1 k, A_{\rm V} = 50$	±3.7	±4.0		V
		$V_{\rm S} = \pm 8 V, R_{\rm L} = 1 k, A_{\rm V} = 50$	±6.6	±7.0		
		$V_{S} = \pm 8V, R_{L} = 300\Omega, A_{V} = 50, (Note 3)$	±6.4	±6.6		
G _E	Gain Error	$V_0 = \pm 1V, A_V = 10, R_L = 1k$		1.0	3.5	%
Is	Supply Current			13	17	mA
	Shutdown Supply Current	Pin 5 at V^- , (Note 11)		0.8	1.5	mA
I _{S/D}	Shutdown Pin Current	Pin 5 at V [−]		5	25	μA

5V ELECTRICAL CHARACTERISTICS $0^{\circ}C \le T_A \le 70^{\circ}C$, (Note 3) $V_S^+ = +5V$, $V_S^- = 0V$, $V_{REF} = 2.5V$, $R_{FB1} = 900\Omega$ from pins 6 to 8, $R_{FB2} = 100\Omega$ from pin 8 to V_{REF} , $R_L = R_{FB1} + R_{FB2} = 1k$, $C_L \le 10pF$, pin 5

open.					LT11890	;	
SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V _{OS}	Input Offset Voltage, (Note 4)	Either Input			1.0	3.0	mV
$\Delta V_{0S} / \Delta T$	Input V _{OS} Drift				5.0		μV/°C
I _{OS}	Input Offset Current	Either Input			0.2	1.5	μA
I _B	Input Bias Current	Either Input			±0.5	±3.5	μA
	Input Voltage Range			2.0		3.5	V
CMRR	Common-Mode Rejection Ratio	V _{CM} = 2.0V to 3.5V		80	100		dB
V _{OUT}	Output Voltage Swing	$R_L = 300\Omega$ to Ground	V _{OUT} High	3.5	4.0		V
		(Note 3)	V _{OUT} Low		0.15	0.4	
Is	Supply Current				12	16	mA
	Shutdown Supply Current	Pin 5 at V, (Note 11)			0.8	1.5	mA
I _{S/D}	Shutdown Pin Current	Pin 5 at V ⁻			5	25	μA

Note 1: A heat sink may be required to keep the junction temperature below absolute maximum when the output is shorted continuously.

Note 2: T_J is calculated from the ambient temperature T_A and power dissipation P_D according to the following formulas:

LT1189MJ8, LT1189CJ8: $T_J = T_A + (P_D \times 100^{\circ}C/W)$ $T_J = T_A + (P_D \times 100^{\circ} \text{C/W})$ LT1189CN8: $T_J = T_A + (P_D \times 150^{\circ}C/W)$ LT1189CS8:

Note 3: When $R_L = 1k$ is specified, the load resistor is $R_{FB1} + R_{FB2}$, but when $R_L = 300\Omega$ is specified, then an additional 430Ω is added to the output such that $(R_{FB1} + R_{FB2})$ in parallel with 430 Ω is $R_L = 300\Omega$.

Note 4: V_{OS} measured at the output (pin 6) is the contribution from both input pair, and is input referred.

Note 5: $V_{IN LIM}$ is the maximum voltage between $-V_{IN}$ and $+V_{IN}$ (pin 2 and pin 3) for which the output can respond.

Note 6: Slew rate is measured between $\pm 1V$ on the output, with a V_{IN} step of ± 0.5 V, A_V = 10 and R_L = 1k.

Note 7: Full power bandwidth is calculated from the slew rate measurement: FPBW = $SR/2\pi Vp$.

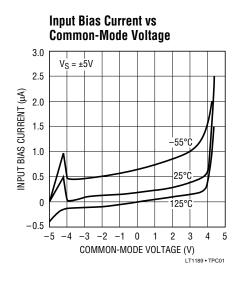
Note 8: Settling time measurement techniques are shown in "Take the Guesswork Out of Settling Time Measurements," EDN, September 19, 1985. Note 9: NTSC (3.58MHz).

Note 10: AC parameters are 100% tested on the ceramic and plastic DIP packaged parts (J8 and N8 suffix) and are sample tested on every lot of the SO packaged parts (S8 suffix).

Note 11: See Application section for shutdown at elevated temperatures. Do not operate shutdown above T_J > 125°C.



TYPICAL PERFORMANCE CHARACTERISTICS



Input Bias Current vs Temperature 100 $V_{\rm S} = \pm 5 V$ +l_B 0 NPUT BIAS CURRENT (nA) -100 -I_B los -200 -300 -400 -50 -25 0 25 50 75 100 125 TEMPERATURE (°C) LT1189 • TPC02

Equivalent Input Noise Current vs

 $V_S = \pm 5V$

 $R_{S} = 100k$

∐ T_A = 25°C

10k

100k

LT1189 • TPC05

Frequency

12

10

8

6

4

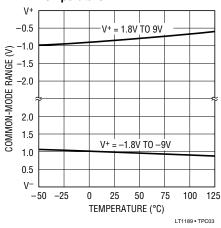
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0

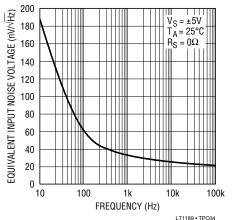
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EQUIVALENT INPUT NOISE CURRENT (pa/ \sqrt{Hz})

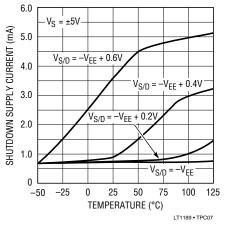
Common-Mode Voltage vs Temperature



Equivalent Input Noise Voltage vs Frequency



Shutdown Supply Current vs Temperature

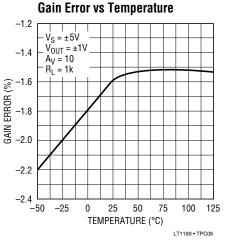


Coin Freeze un Tomporature

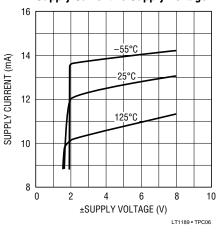
1k

FREQUENCY (Hz)

100

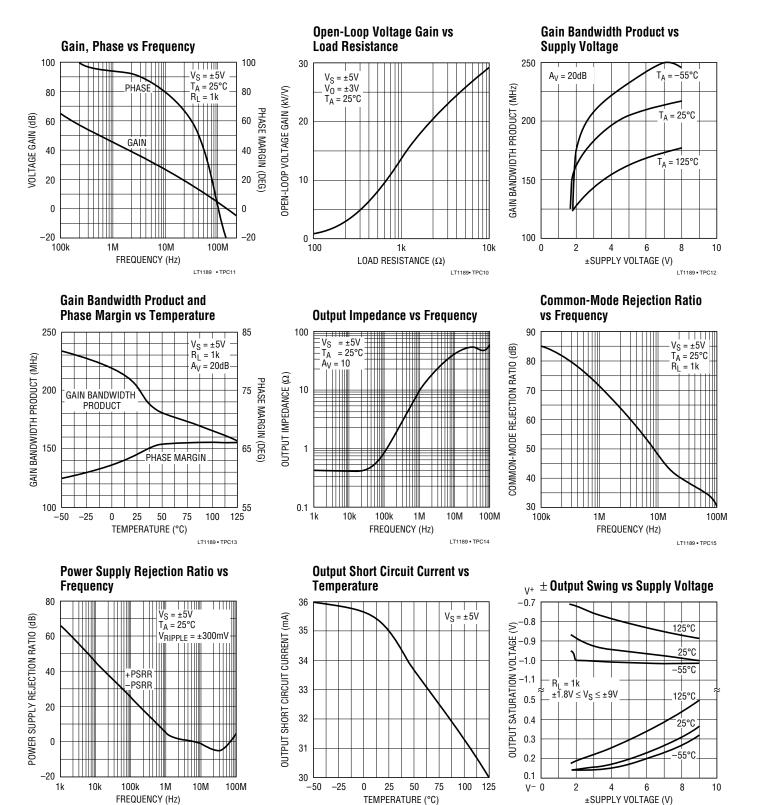


Supply Current vs Supply Voltage



Open-Loop Gain vs Temperature 16 $V_S = \pm 5V$ 14 $V_0^{\circ} = \pm 3V$ 12 OPEN-LOOP GAIN (kV/V) 10 $R_{\rm L} = 500\Omega$ 8 6 4 2 0 -50 -25 0 25 50 75 100 125 TEMPERATURE (°C) LT1189 • TPC09

TYPICAL PERFORMANCE CHARACTERISTICS



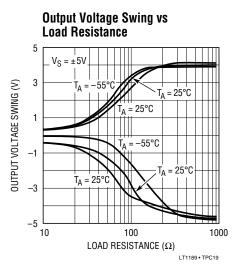
LT1189 • TPC17



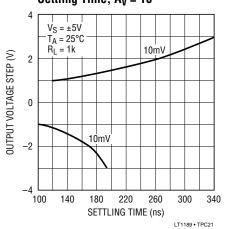
LT1189 • TPC18

LT1189 • TPC16

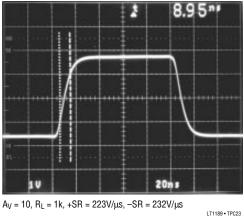
TYPICAL PERFORMANCE CHARACTERISTICS

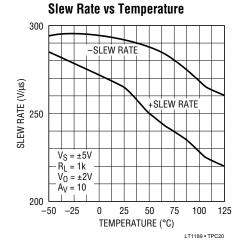


Output Voltage Step vs Settling Time, $A_V = 10$

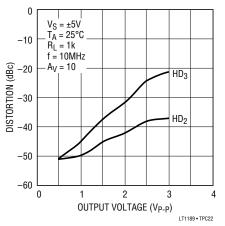


Large-Signal Transient Reponse

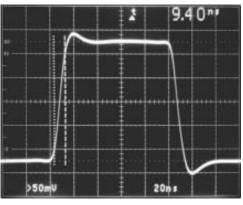




Harmonic Distortion vs **Output Level**



Small-Signal Transient Reponse



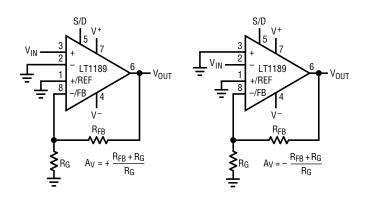
 $A_V = 10, R_L = 1k, t_r = 9.40ns$

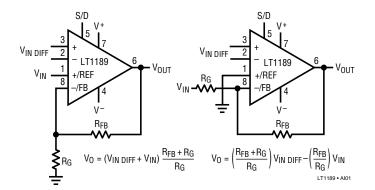
LT1189 • TPC24



The primary use of the LT1189 is in converting high speed differential signals to a single-ended output. The LT1189 video difference amplifier has two uncommitted high input impedance (+) and (-) inputs. The amplifier has another set of inputs which can be used for reference and feedback. Additionally, this set of inputs give gain adjust, and DC control to the differential amplifier. The voltage gain of the LT1189 is set like a conventional operational amplifier. Feedback is applied to pin 8, and it is optimized for gains of 10 or greater. The amplifier can be operated single-ended by connecting either the (+) or (-) inputs to the +/REF (pin 1). The voltage gain is set by the resistors: ($R_{FB} + R_G$)/ R_G .

Like the single-ended case, the differential voltage gain is set by the external resistors: $(R_{FB} + R_G)/R_G$. The maximum input differential signal for which the output will respond is approximately ± 170 mV.





Power Supply Bypassing

The LT1189 is quite tolerant of power supply bypassing. In some applications a 0.1μ F ceramic disc capacitor placed 1/2 inch from the amplifier is all that is required. In applications requiring good settling time, it is important to use multiple bypass capacitors. A 0.1μ F ceramic disc in parallel with a 4.7μ F tantalum is recommended.

Calculating the Output Offset Voltage

Both input stages contribute to the output offset voltage at pin 6. The feedback correction forces balance in the input stages by introducing an Input V_{OS} at pin 8. The complete expression for the output offset voltage is:

$$V_{OUT} = (V_{OS} + I_{OS}(R_S) + I_B(R_{REF})) \times (R_{FB} + R_G)/R_G + I_B(R_{FB})$$

 R_S represents the input source resistance, typically 75 Ω , and R_{REF} represents finite source impedance from the DC reference voltage, for V_{REF} grounded, $R_{REF} = 0\Omega$ the I_{OS} is normally a small contributor and the expression simplifies to:

 $V_{OUT} = V_{OS}(R_{FB} + R_G)/R_G + I_B(R_{FB})$

If R_{FB} is limited to 1k, the last term of the equation contributes only 2mV since I_B is less than $2\mu A$.

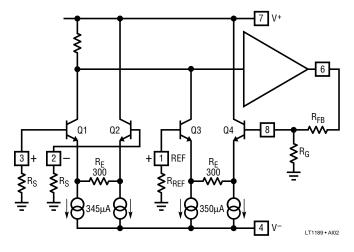


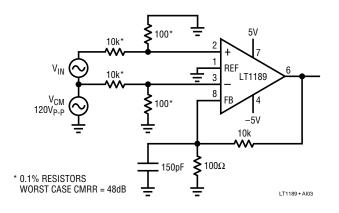
Figure 1. Simplified Input Stage Schematic



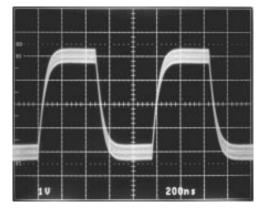
Instrumentation Amplifier Rejects High Voltage

Instrumentation amplifiers are often used to process slowly varying outputs from transducers. With the LT1189 it is easy to make an instrumentation amplifier that can respond to rapidly varying signals. Attenuation resistors in front of the LT1189 allow very large common-mode signals to be rejected while maintaining good frequency response. The input common-mode and differential-mode signals are reduced by 100:1, while the closed-loop gain is set to be 100, thereby maintaining unity-gain input to output. The unique topology allows for frequency response boost by adding 150pF to pin 8 as shown.

3.5MHz Instrumentation Amplifier Rejects 120V_{P-P}



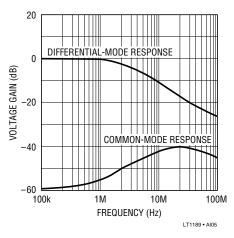
Output of Instrumentation Amplifier with 1MHz Square Wave Riding on $120 V_{P\!\cdot\!P}$ at the Input



LT1189 • AI04



High Voltage Instrumentation Amplifier Response



Operating with Low Closed-Loop Gain

The LT1189 has been optimized for closed-loop gains of 10 or greater. The amplifier can be operated at much lower closed-loop gains with the aid of a capacitor C_{FB} across the feedback resistor, (feedback zero). This capacitor lowers the closed-loop 3dB bandwidth. The bandwidth cannot be made arbitrarily low because C_{FB} is a short at high frequency and the amplifier will appear configured unity-gain. As an approximate guideline, make BW × A_{VCL} = 200MHz. This expression expands to:

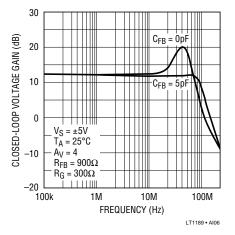
$$\frac{A_{VCL}}{2\pi(R_{FB})(C_{FB})} = 200MHz$$

or:

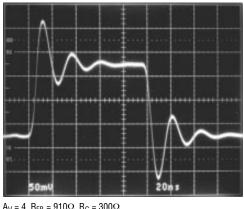
$$C_{FB} = \frac{A_{VCL}}{(200MHz)(2\pi)(R_{FB})}$$

The effect of the feedback zero on the transient and frequency response is shown for $A_V = 4$.

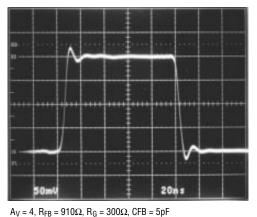
Closed-Loop Voltage Gain vs Frequency



Small-Signal Transient Response



 $A_V=4,\,R_{FB}=910\Omega,\,R_G=300\Omega$



Small-Signal Transient Response

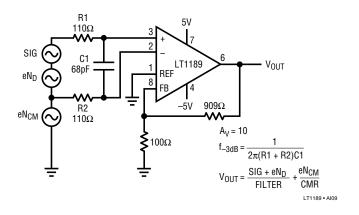
LT1189 • AI08

LT1189 • AI07

Reducing the Closed-Loop Bandwidth

Although it is possible to reduce the closed-loop bandwidth by using a feedback zero, instability can occur if the bandwidth is made too low. An alternate technique is to do differential filtering at the input of the amplifier. This technique filters the differential input signal, and the differential noise, but does not filter common-mode noise. Common-mode noise is rejected by the LT1189's CMRR.

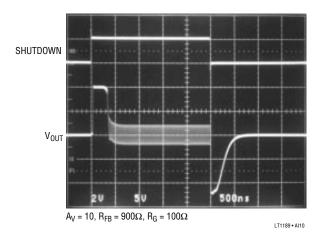




Using the Shutdown Feature

The LT1189 has a unique feature that allows the amplifier to be shutdown for conserving power, or for multiplexing several amplifiers onto a common cable. The amplifier will shutdown by taking pin 5 to V^- . In shutdown, the amplifier dissipates 15mW while maintaining a true high impedance output state of about $20k\Omega$ in parallel with the feedback resistors. For MUX applications, the amplifiers may be configured inverting, non-inverting, or differential. When the output is loaded with as little as $1k\Omega$ from the amplifier's feedback resistors, the amplifier shuts off in 600ns. This shutoff can be under the control of HC CMOS operating between 0V and -5V.

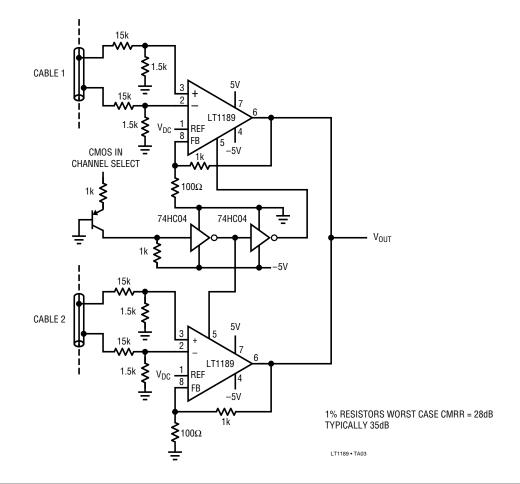




1MHz Sine Wave Gated Off with Shutdown Pin

The ability to maintain shutoff is shown on the curve Shut down Supply Current vs Temperature in the Typical Performance Characteristics section. At very high elevated temperature it is important to hold the shutdown pin close to the negative supply to keep the supply current from increasing.

TYPICAL APPLICATION

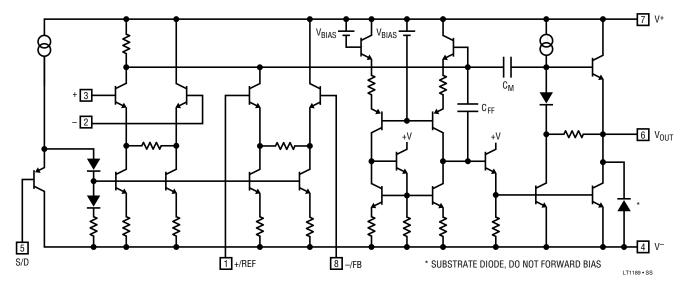


Differential Receiver MUX for Power Down Applications

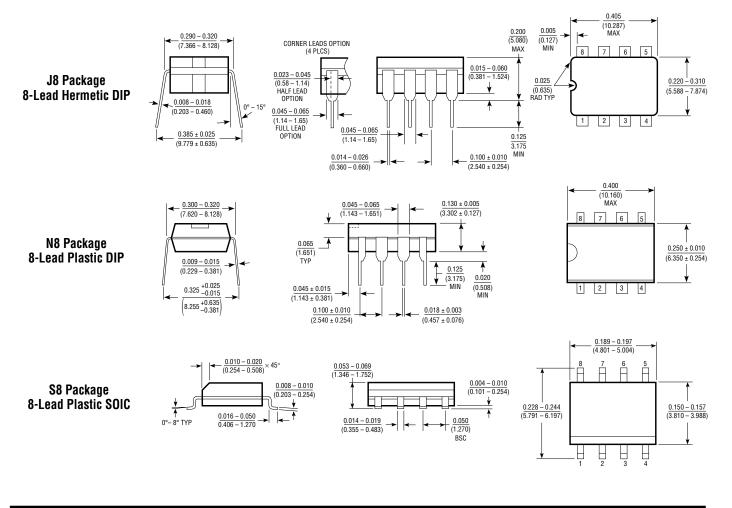


Information furnished by Linear Technology Corporation is believed to be accurate and reliable. However, no responsibility is assumed for its use. Linear Technology Corporation makes no representation that the interconnection of its circuits as described herein will not infringe on existing patent rights.

SIMPLIFIED SCHEMATIC



PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.



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